

Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.540/g
Number of Rows	2
Orientation	Right Angle
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Packaging Type	Tray
Pitch - Mating Interface	3.00mm
Plating min - Mating	0.381µm
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40° to +125°C
Termination Interface: Style	Through Hole
Electrical	
Current - Maximum per Contact	8.5A
Voltage - Maximum	600V
Solder Process Data	
Duration at Max. Process Temperature (seconds)	030
Lead-freeProcess Capability	SMC&WAVE
Max. Cycles at Max. Process Temperature	003
Process Temperature max. C	260
Material Info	
Reference - Drawing Numbers	
Application Specification	AS-43045-001-001
Packaging Specification	PK-70873-0313-001
Product Specification	430450001-PS-KO-000, 430450001-PS-SP-000, PS-43045-001
Sales Drawing	SD-43045-001-001, SDIN-43045-0001-001
Symbol/Footprint Data	SYM-43045-0200-001
Test Summary	430450005-TS-000, 430450006-TS-000, TS-43045-001-001, TS-43045-002-001, TS-46235-001-001

This document was generated on 10/05/2021

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION